



Product Change Notification

Change Notification #: 115909 - 00
Change Title: Intel® Core™ i5-8400 Processor,
 Intel® Core™ i5-8600K Processor,
 Intel® Core™ i7-8700 Processor,
 Intel® Core™ i7-8700K Processor,
 PCN 115909-00, Manufacturing Site, Label
 Notification to Customers for Addition of
 Factory Assembly/Test Site
Date of Publication: November 15, 2017

Key Characteristics of the Change:
 Manufacturing Site, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	December 15, 2017
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Description of Change to the Customer:

In order to ensure a continuous supply of the Intel® Core™ i5-8400 Processor, Intel® Core™ i5-8600K Processor, Intel® Core™ i7-8700 Processor, and Intel® Core™ i7-8700K Processor listed in the "Products Affected" Table below, Intel will be adding an additional manufacturing site for Assembly/Test. The new site is located in Chengdu, China. The new manufacturing site has been certified equivalent (form, fit, function, and reliability) for the affected products and technologies of this change.

Due to this change, the "ASSEMBLED IN Country" on the Box Label will now include China. See label example below - This label is a representation for example purposes only. The actual label will reflect correct product data.

Malaysia		If the Country of Origin (COO) identification is marked on the product, this will now display MALAY.
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China	<p> (CP) CUST PROD: (1B) BOX: RLX00036 (CV) SUPPLIER: 04195 INTEL (C1P) IPN: INTEL PRODUCT NAMEXX (S) SPEC: S 1234 (30P) MM#: 123456 (1T) LOT: FPO NUMBER (Q) QTY: 12345 (3D) DATE: YYWW (1T) LOT: (Q) QTY: (3D) DATE: RoHS COMPLIANT, e1 </p>	If the Country of Origin (COO) identification is marked on the product, this will now display CHINA.
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If the Country of Origin (COO) identification is marked on the product, this will now display MALAY or CHINA. (See generic label template).

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers for this change. Customers should notify their receiving department of the additional country which will be providing the Test/Finish on the products. It possible that Customers may receive a mix of material from both sites.

Customers may contact their Intel Field Sales Representative or the contacts listed on the last page of this Product Change Notification appropriate to your geo with questions.

Fabrication (Fab), sort, and assembly test facilities follow a Copy Exactly! (CE!) philosophy. Copy Exactly! enables delivery of product from multiple production sites, which operate as a virtual factory that performs consistently and independent of the manufacturing source site. Additional benefits include faster production ramps that improve product availability and improved consistency to quality performance.

Learn more about CE! at <http://www.intel.com/content/www/us/en/quality/exact-copy.html> web site.

Products Affected / Intel Ordering Codes:

Marketing Name	Stepping	Product Code	S-Spec	MM#
Intel® Core™ i7-8700K Processor	U0	CM8068403358220	S R3QR	960617
Intel® Core™ i7-8700 Processor	U0	CM8068403358316	S R3QS	960618
Intel® Core™ i5-8400 Processor	U0	CM8068403358811	S R3QT	960619
Intel® Core™ i5-8600K Processor	U0	CM8068403358508	S R3QU	960620

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
November 15, 2017	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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Japan Email: jccb.ijkk@intel.com

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